14:20PM-15:10PM A Silicon Photonics Platform with Heterogeneous III-V Integration

Wim Bogaerts Ghent University, Belgium

Abstract: We will present an overview of the work by Ghent University and imee on a multipurpose photonic platform based on silicon technology with heterogeneous integration of III-V materials. Silicon photonics is widely considered to be the most promising technology to realize a high-performance, low-cost and high-volume photonic platform that can enable complex VLSI photonic functionality. One of the key enablers for silicon photonics is the possibility leverage existing silicon processing technology. Silicon as a material is exceptionally suited for compact passive waveguide circuits, but for light detection, and especially generation, III-V materials are by far superior. Heterogeneous integration of III-V materials on silicon photonic circuits has already been demonstrated in working lasers and efficient photodetectors. We will discuss the recent progress in adhesive III-V-on-silicon bonding technology, with working lasers, microlasers and different types of photodetectors, and how these devices can be used for different purposes. III-V integration can only be successful if integrated in a fully functional silicon photonics platform. III-V materials are typically not used in a silicon process environment. To accommodate the III-V materials inside a silicon process flow, careful considerations have to be made for contamination and temperature budget. Imec is constructing a full silicon photonics platform which not only integrates passive silicon photonics, but also modulators, germanium photodetectors, thermal tuning, III-V integration and 3-D integration with electronics



Biography: Wim Bogaerts received a PhD in 2004 from Ghent University in 2004, on the design and fabrication of nanophotonic components, and especially photonic crystals using silicon technology. He continued to work on the subject of silicon photonics, co-ordinating the activities between the photonics group and the silicon process technology group in IMEC for the fabrication of SOI photonic nanostructures with advanced CMOS tools. This work spurred collaborations with tens of partners all over the world to combine nanophotonic designs into multi-project-wafer runs in IMEC, an activity

which is now running as the silicon photonics platform ePIXfab. Currently he is still active in the photonics group as a postdoctoral researcher of the Flemish Science Foundation (FWO), active in both Ghent University and imec, coordinating the silicon photonics work, with a strong focus on active elements (modulators, detectors, tuners) and integration of silicon photonics with other technologies using 3D integration. He keeps a strong interest in telecommunications, information technology and applied sciences. He is a member of IEEE-LEOS and the Optical Society of America (OSA).

Workshop on Frontiers in Silicon Photonics Program

Venue: Multifunction Hall, 2nd Floor Jadepalace Hotel Beijing China

	8:30-8:50	Opening Remarks
	8:50-9:40	Communication Technology Roadman
		Jurgen Michel Massachusetts Institute of Technology, USA
AM, August 29	9:40-10:30	Optical Communication Evolution
		Li Zeng Huawei Technologies Co., China
Session Chair:	10.30-10:50	Tea break and group photo at the entrance of Jadepalace Hotel
Zhiping Zhou	10:50-11:40	Scaling Size & Power in Silicon Photonics
		Tom Koch Lehigh University, USA
	11:40-12:30	Chip-to-Chip Optical Interconnects
		Mehdi Asghari Kotura, Inc., USA
	12:30-13:30	Lunch (The Gallery Coffee Shop, 2nd Floor)
PM, August 29 Session Chair : Mehdi Asghari	13:30-14:20	Si MEMS Photonics for Electronics and Photonics Convergence on CMOS Platform
		CMOS Platform
		Kazumi Wada Tokyo University, Japan
	14:20-15:10	A Silicon Photonics Platform with Heterogeneous III-V Integration
		Wim Bogaerts Ghent University, Belgium
	15:10-15:30	Tea break
	15:30-16:20	Silicon Photonic Devices for on-chip Microsystems
		Zniping Zhou Peking University China
	16:20-17:10	Lotus Surface Structure with 7nO Nanowing 6
		Efficiency Solar Cells Ching Ping Way
	17:30-20:00	Ching Ping Wong Georgia Institute of Technology, USA Dinner speech: Si Photonics and China
		Speaker: Andrew Richman, Chairman, Votant
	 	Tomo Fu Gong Sni Fu. 2nd Floor)
M, August 30	8:30-9:20	A High Speed 4-Channel Integrated Silican Di
		Hybrid Silicon Lasers Haisheng Rong June 16
	9:20-10:10	Haisheng Rong Intel Corporation, USA Silicon Based On Chip Photograph (2)
		Silicon Based On Chip Photonic Quantum Dots and Photonic Molecules Kunji Chen Nanjing University, China
ssion Chair :	10:10-10:30	Tea break
om Koch	10:30-11:20	Phosphorus and Boron Doping of Silicon Nanocrystals
		Deren Yang Zhejiang University, China
	11:20-12:10	Si Nanodot Photonics
		Lorenzo Pavesi University of Trento, Italy
	12:10-13:30	Lunch (Korean Restaurant, 2nd Floor)
-	13:30-14:20	Silicon Based Organic/inorganic Optoelectronic Materials and Application
		Wei Huang Nanjing University of Posts and Telecommunications, China Chemical and Riological Communications and Telecommunications.
	14:20-15:10	Chemical and Biological Sensing with Photonic Crystal Devices Made of Silicon

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